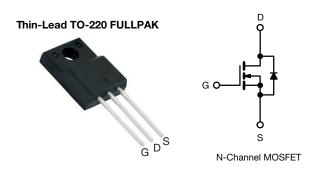
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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.305				
Q _g max. (nC)	54				
Q _{gs} (nC)	7				
Q _{gd} (nC)	15				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 Fullpack			
Lead (Pb)-free and halogen-free	SIHA15N80AEF-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	800		
Gate-source voltage			V _{GS}	± 30	V	
Continuous dusin surrent (T 150 °C) e	N	T _C = 25 °C	- I _D	6	А	
Continuous drain current (T _J = 150 °C) ^e	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		4		
Pulsed drain current ^a			I _{DM}	28	1	
Linear derating factor				0.26	W/°C	
Single pulse avalanche energy ^b			E _{AS}	28	mJ	
Maximum power dissipation			P _D	33	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope		T _J = 125 °C	100		N//	
Reverse diode dv/dt ^d			dv/dt	15	V/ns	
Soldering recommendations (peak temperature) ^c		For 10 s	-	260	°C	
Mounting torque	M3 s	screw	-	0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,$ I_{AS} = 1.4 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

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PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		65					
Maximum junction-to-case (drain)	R _{thJC}	-	- 3.8			°C/W			
		•							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherwi	ise noted)							
PARAMETER	SYMBOL		TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static						1	1	1	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	V _{GS} = 0 V, I _D = 250 μA		800	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.7	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 2		2	-	4	V	
		,	$V_{GS} = \pm 20$	V	-	-	± 100	nA	
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA	
			= 640 V, V _G		-	-	1	μΑ	
Zero gate voltage drain current	IDSS	V _{DS} = 640 V	/, V _{GS} = 0 V	′, T _J = 125 °C	-	-	2	mA	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	1	₀ = 6.5 A	-	0.305	0.350	Ω	
Forward transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 6.5 A		-	7.0	-	S		
Dynamic	-				•				
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1128	-	pF		
Output capacitance	C _{oss}			-	41	-			
Reverse transfer capacitance	C _{rss}			-	5	-			
Effective output capacitance, energy related	C _{o(er)}	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	34	-			
Effective output capacitance, time related	C _{o(tr)}			-	209	-			
Total gate charge	Qg	V _{GS} = 10 V I _D = 6.5 A, V _{DS} = 640 V		-	36	54	nC		
Gate-source charge	Q _{gs}			-	7	-			
Gate-drain charge	Q _{gd}				-	15	-	1	
Turn-on delay time	t _{d(on)}				-	14	28		
Rise time	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}}=640 \; \text{V}, \; I_{\text{D}}=6.5 \; \text{A}, \\ V_{\text{GS}}=10 \; \text{V}, \; R_{g}=9.1 \; \Omega \end{array}$		-	14	28	ns		
Turn-off delay time	t _{d(off)}			-	18	36			
Fall time	t _f			-	43	86			
Gate input resistance	R _g	f = 1 MHz, open drain		0.2	0.5	1.1	Ω		
Drain-Source Body Diode Characteris									
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6	•		
Pulsed diode forward current	I _{SM}			-	-	28	A		
Diode forward voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 6.5 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V		
Reverse recovery time	t _{rr}	$T_{\rm J} = 25 ^{\circ}\text{C}, I_{\rm F} = I_{\rm S} = 6.5 \text{A}, \\ \text{di/dt} = 100 \text{A/}\mu\text{s}, \text{V}_{\rm R} = 25 \text{V}$		-	104	208	ns		
Reverse recovery charge	Q _{rr}			-	0.4	0.8	μΟ		
Reverse recovery current	I _{RRM}			-	8	-	A		

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

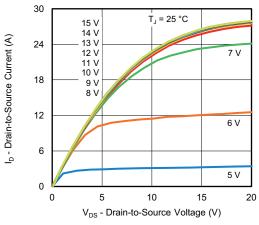


Fig. 1 - Typical Output Characteristics

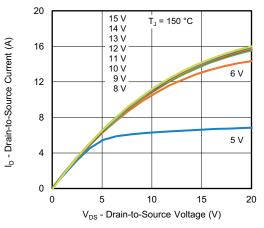


Fig. 2 - Typical Output Characteristics

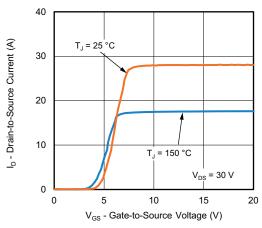


Fig. 3 - Typical Transfer Characteristics

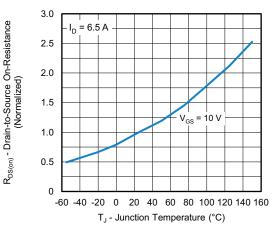


Fig. 4 - Normalized On-Resistance vs. Temperature

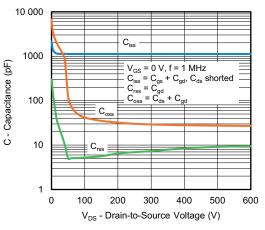


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

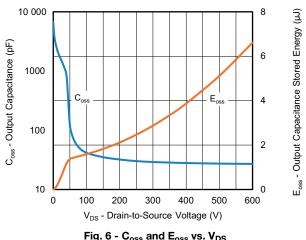


Fig. 6 - Coss and Eoss vs. VDS

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8

6

4

2

0

1.2

1.1

1

0.9

0.8

-60 -40 -20

0

V_{DS} - Drain-to-Source Breakdown Voltage

(Normalized)

25

50

75

T_c - Case Temperature (°C)

Fig. 10 - Maximum Drain Current vs. Case Temperature

100

125

 $I_D = 1 \text{ mA}$

20 40 60 80 100 120 140 160

T_J - Junction Temperature (°C)

Fig. 11 - Temperature vs. Drain-to-Source Voltage

150

l_D - Drain Current (A)

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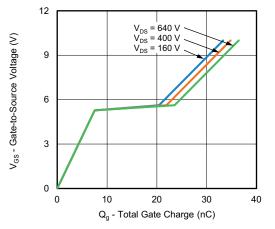


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

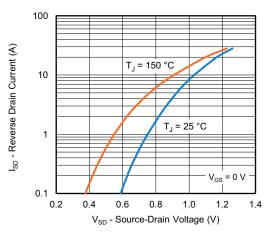


Fig. 8 - Typical Source-Drain Diode Forward Voltage

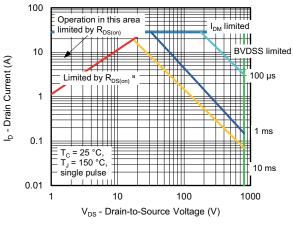


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

4



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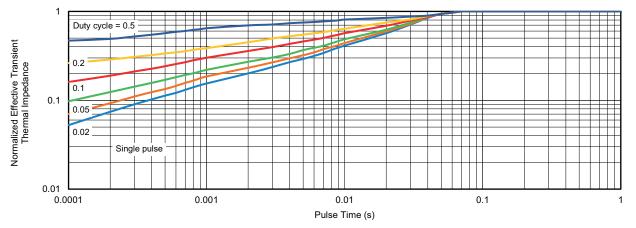


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

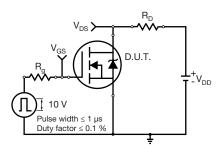


Fig. 13 - Switching Time Test Circuit

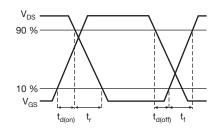


Fig. 14 - Switching Time Waveforms

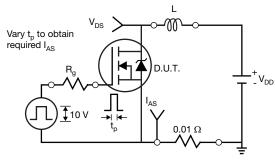


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

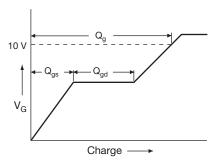


Fig. 17 - Basic Gate Charge Waveform

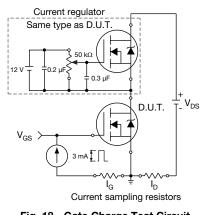


Fig. 18 - Gate Charge Test Circuit

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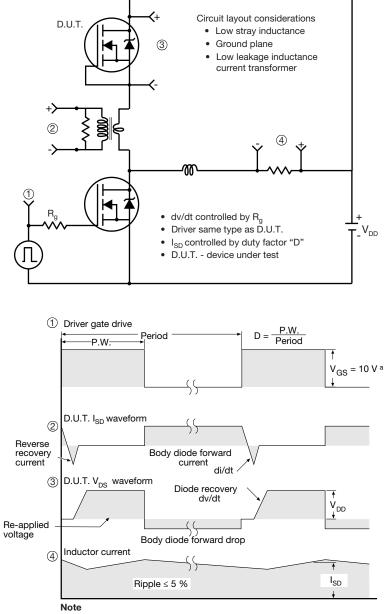
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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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